

## IRF9533PBF-VB Datasheet P-Channel 60-V (D-S) MOSFET

PRODUCT SUMMARY		
V <sub>DS</sub>	-60	V
R <sub>DS(on)</sub> V <sub>GS</sub> = 10 V	62	mΩ
$R_{DS(on)}$ $V_{GS} = 4.5$ V	74	mΩ
I <sub>D</sub>	-40	А
Configuration	Sin	gle

## FEATURES

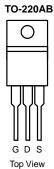
- Trench Power MOSFET
- 100 % UIS Tested

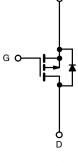
#### **APPLICATIONS**

Load Switch

S







P-Channel MOSFET
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Parameter		Symbol	Limit	Unit	
Gate-Source Voltage	V <sub>GS</sub>	± 20	V		
Continuous Drain Current (T <sub>J</sub> = 175 °C)	T <sub>C</sub> = 25 °C	1-	-40		
	T <sub>C</sub> = 100 °C	I <sub>D</sub>	-30		
Pulsed Drain Current		I <sub>DM</sub>	- 90	A	
Continuing Source Current (Diode Conduction)		۱ <sub>S</sub>	- 30		
Avalanche Current		I <sub>AS</sub>	- 28	1	
Single Pulse Avalanche Energy	L = 0.1 mH	E <sub>AS</sub>	7.2	mJ	
Maximum Power Dissipation	T <sub>C</sub> = 25 °C	P <sub>D</sub>	60 <sup>a</sup>	w	
	T <sub>A</sub> = 25 °C		2 <sup>b</sup>	vv	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
hunding to Ambient	$t \le 10 \text{ sec}$	R <sub>thJA</sub>	20	25	
Junction-to-Ambient <sup>D</sup>	Steady State	' 'thJA	62	75	°C/W
Junction-to-Case		R <sub>thJC</sub>	5	6	

Notes:

a. See SOA curve for voltage derating.

b. Surface Mounted on 1" x 1" FR-4 boad.

<b>SPECIFICATIONS</b> $T_J = 25$	°C, unless o	otherwise noted				
Parameter	Symbol	Test Conditions	Min	Typ <sup>a</sup>	Max	Unit
Static						
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{GS} = 0 V, I_D = -250 \mu A$	- 60			V
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	- 1.0		- 3.0	v
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V$ , $V_{GS} = \pm 20 V$			± 100	nA
		$V_{DS} = -60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			- 1	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS}$ = - 60 V, $V_{GS}$ = 0 V, $T_{J}$ = 125 °C			- 50	μΑ
		$V_{DS}$ = - 60 V, $V_{GS}$ = 0 V, $T_{J}$ = 175 °C			- 150	
On-State Drain Current <sup>b</sup>	I <sub>D(on)</sub>	$V_{DS} = -5 V, V_{GS} = -10 V$	- 10			А
		V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 5 A		62		
Drain Courses On State Desistance	rea( )	$V_{GS}$ = - 10 V, I <sub>D</sub> = - 5 A, T <sub>J</sub> = 125 °C		80		
Drain-Source On-State Resistance <sup>b</sup>	r <sub>DS(on)</sub>	$V_{GS}$ = - 10 V, I <sub>D</sub> = - 5 A, T <sub>J</sub> = 175 °C		110		mΩ
		V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 2 A		74		
Forward Transconductance <sup>b</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = - 15 V, I <sub>D</sub> = - 5 A		8		S
Dynamic				-		
Input Capacitance	C <sub>iss</sub>			1300		
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = - 25 V, V <sub>GS</sub> = 0 V, f = 1 MHz		120		pF
Reverse Transfer Capacitance	C <sub>rss</sub>			90		
Total Gate Charge	Qg			13		
Gate-Source Charge	Q <sub>gs</sub>	V <sub>DS</sub> = - 30 V, V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 8.4 A		2.3		nC
Gate-Drain Charge	Q <sub>gd</sub>			3.2		
Gate Resistance	R <sub>g</sub>	f = 1 MHz		8.0		Ω
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>			5	10	
Rise Time <sup>c</sup>	t <sub>r</sub>	$V_{DD}$ = - 30 V, $R_L$ = 3.57 $\Omega$		14	25	20
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>	$\text{I}_\text{D}\cong$ - 8.4 A, $\text{V}_\text{GEN}$ = - 10 V, $\text{R}_\text{G}$ = 2.5 $\Omega$		15	25	ns
Fall Time <sup>c</sup>	t <sub>f</sub>			7	12	
Source-Drain Diode Ratings and Cha	racteristics	(T <sub>C</sub> = 25 °C) <sup>b</sup>		•		
Pulsed Current	I <sub>SM</sub>			- 20		А
Forward Voltage <sup>b</sup>	V <sub>SD</sub>	I <sub>F</sub> = - 2 A, V <sub>GS</sub> = 0 V		- 0.9	- 1.3	V
Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = - 8 A, di/dt = 100 A/μs		50	80	ns
Reverse Recovery Time	Q <sub>rr</sub>	$r_{\rm F} = -0.7$ , $u_0 u_1 = -00.7$ , $\mu_0$		80	120	nC

Notes:

a. Guaranteed by design, not subject to production testing.

b. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.

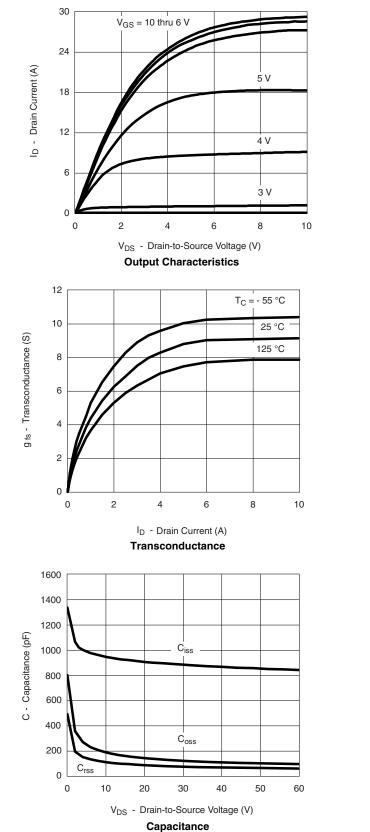
c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

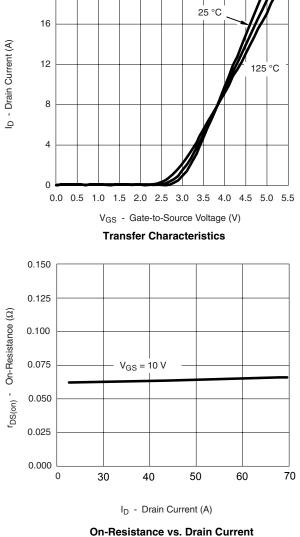
VBsemi Bsemi.com



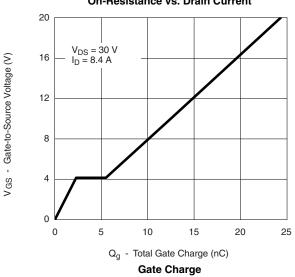
T<sub>C</sub> = - 55 °C



### TYPICAL CHARACTERISTICS 25 °C unless noted



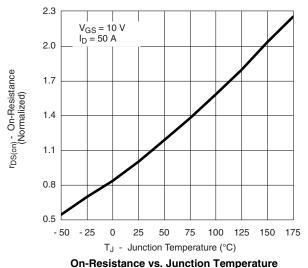
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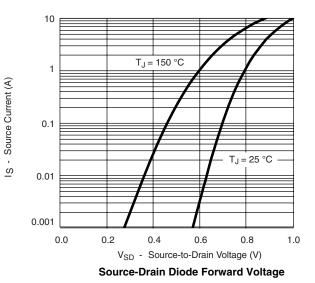


服务热线: 400-655-8788

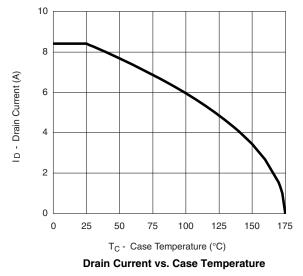


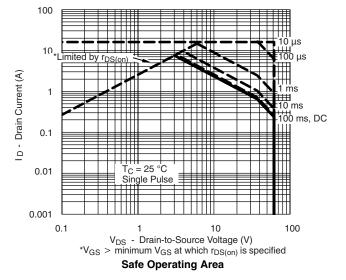
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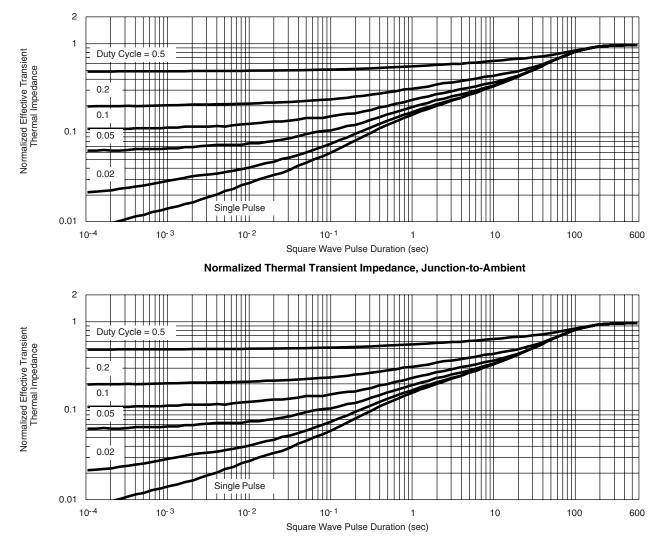
## THERMAL RATINGS





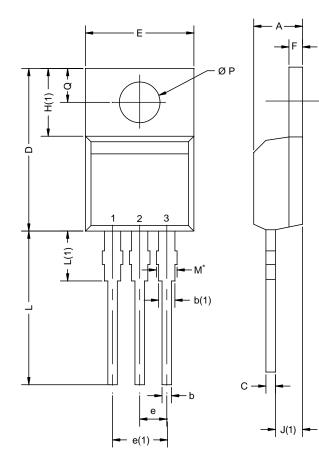


#### THERMAL RATINGS



Normalized Thermal Transient Impedance, Junction-to-Case





# TO-220AB

	MILLIM	IETERS	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX	
А	4.25	4.65	0.167	0.183	
b	0.69	1.01	0.027	0.040	
b(1)	1.20	1.73	0.047	0.068	
С	0.36	0.61	0.014	0.024	
D	14.85	15.49	0.585	0.610	
Е	10.04	10.51	0.395	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.09	6.48	0.240	0.255	
J(1)	2.41	2.92	0.095	0.115	
L	13.35	14.02	0.526	0.552	
L(1)	3.32	3.82	0.131	0.150	
ØР	3.54	3.94	0.139	0.155	
Q	2.60	3.00	0.102	0.118	

#### Notes

 $^{\star}$  M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM



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